NMUX1308

1.5 V to 5.5 V, 8-channel analog switch multiplexer and demultiplexer with injection-current control

Rev. 1.2 — 16 April 2024 Product data sheet

1. General description

The NMUX1308 is a general purpose, CMOS, bi-directional, 8 channel analog switch, with an operating voltage range of 1.5 V to 5.5 V. The NMUX1308 is dual source compatible with existing 4851 and 4051 devices. The NMUX1308 extends the digital logic thresholds to be compatible with 1.8 V systems without the need for voltage translation.

The analog signal pins are comprised of a common input/output (Z) and eight independent inputs/outputs (Y0 to Y7). All analog signal pins are bi-directional and support a voltage range from GND to V_{CC}.

All analog signal pins integrate injection current control circuitry. This control circuitry isolates overvoltage spikes on disconnected analog signal pins from coupling to the connected analog signal path, thereby preserving measurement accuracy. Additionally, this integration makes the use of external overvoltage clamp components (e.g. resistive diode network) unnecessary.

There are four control signal pins (S0, S1, S2, and $\overline{E}$). S0, S1, and S2 determine the analog channels to connect between Z and Yn. $\overline{E}$ can be used to override S0, S1, and S2, disconnecting all analog channels.

The control signal pins support 1.8 V logic thresholds across all operating voltages. In addition, these pins are 5.5 V tolerant, enabling up to 5.5 V operation independent of supply voltage.

2. Features and benefits

- SP8T-Z functionality
- Wide operating range: 1.5 V to 5.5 V
- Rail-to-Rail operation on analog signal pins
- Injection current control
- 1.8 V digital logic thresholds
  - Digital pins compatible with 1.8 V logic thresholds across full V_{CC} range
  - Removes need for up-translation device for compatibility with low voltage GPIOs
- I_{off} circuitry
  - Enables wider latitude for power sequencing considerations
  - Isolates backflow between supply rail and any biased digital/analog input when V_{CC} = 0 V
  - Prevents any biased digital/analog input from backpowering V_{CC} when V_{CC} = 0 V
  - Maintains Hi-Z state of analog switch when V_{CC} = 0 V
- 5.5 V overvoltage tolerant digital inputs
  - Supports switching of 5.5 V digital signals across full V_{CC} operating range
  - Removes need for down-translation when switching thresholds are met
- Pin compatible with industry standard 4051 and 4851 analog switch products
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C2b exceeds 750 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

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3. Applications

- Analog or digital multiplexing/demultiplexing
- System monitoring and diagnostics
- Enterprise computing
- Appliances

4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
NMUX1308PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
NMUX1308BQ	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm	SOT763-1

5. Marking

Table 2. Marking

Type number	Marking code
NMUX1308PW	NMU1308
NMUX1308BQ	NM1308

6. Functional diagram

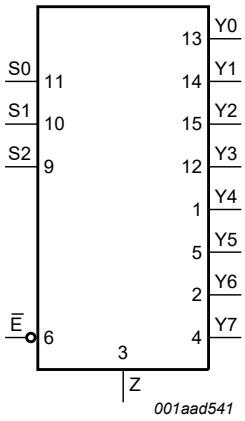


Fig. 1. Logic symbol

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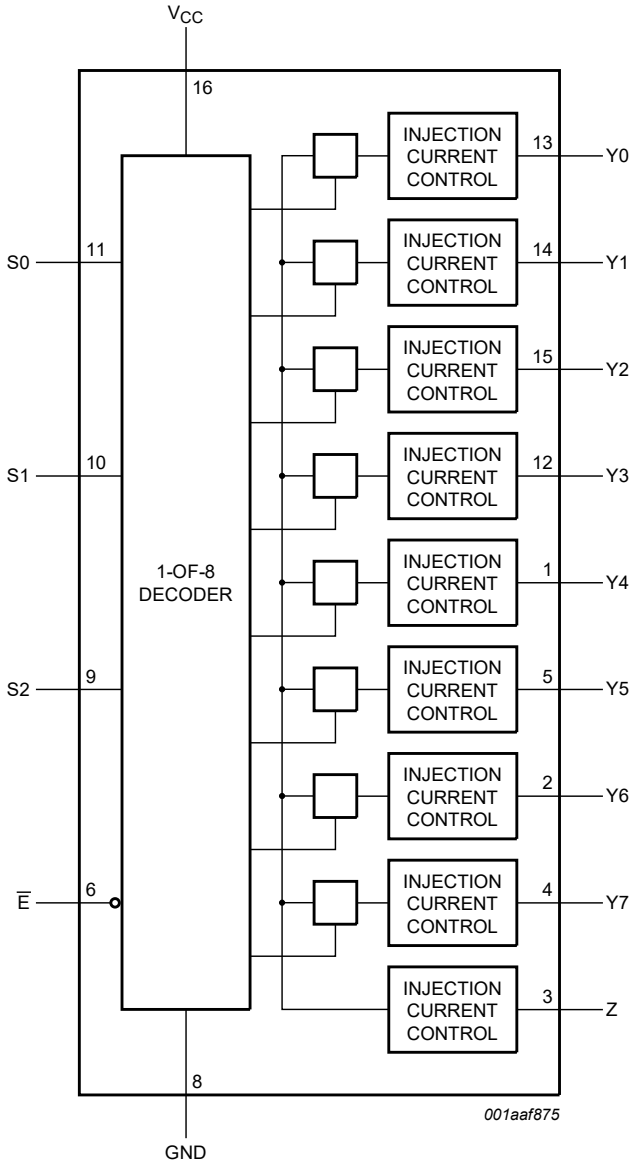
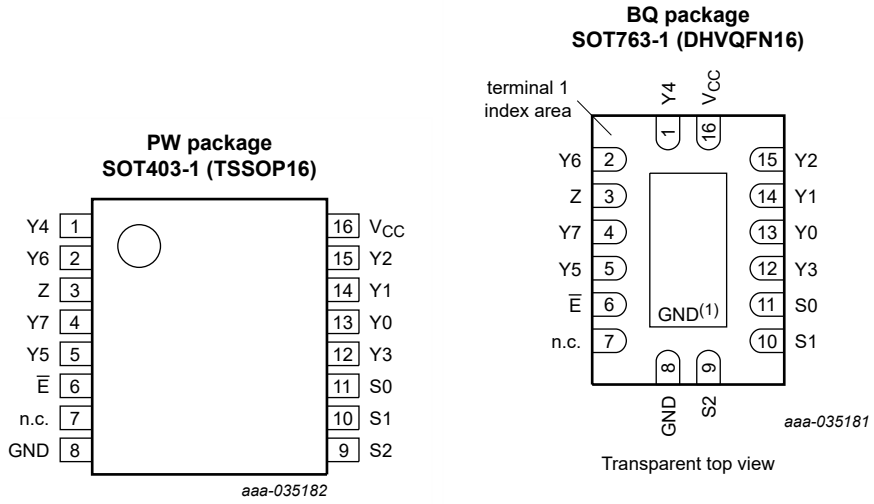


Fig. 2. Functional diagram

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7. Pinning information

7.1. Pinning



(1) This is not a supply pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

7.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
Y4	1	independent input/output
Y6	2	independent input/output
Z	3	common input/output
Y7	4	independent input/output
Y5	5	independent input/output
$\overline{E}$	6	enable input (active LOW); do not leave this pin floating
n.c.	7	not connected
GND	8	ground (0 V)
S2	9	select input; do not leave this pin floating
S1	10	select input; do not leave this pin floating
S0	11	select input; do not leave this pin floating
Y3	12	independent input/output
Y0	13	independent input/output
Y1	14	independent input/output
Y2	15	independent input/output
V_{CC}	16	supply voltage

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8. Functional description

8.1. Overview

The NMUX1308 is a general purpose analog switch with a single pole that can be configured to select between one of eight possible connection paths (SP8T). Each analog connection path is bi-directional, with similar electrical characteristics independent of the direction of signal propagation.

8.2. Key features

Injection current control

Current injection can occur in systems where an analog voltage can experience transient spikes due to signal propagation over long distances with high inductance. Voltage exposure above the supply voltage will source excessive current into an analog input, which is referred to as positive injection. Voltage exposure below the ground voltage will sink excessive current from an analog input, which is referred to as negative injection. Both types of injection current elevate the risk of device damage to an analog input and can introduce a large voltage error to the analog signal itself.

The NMUX1308 mitigates both risks by integrating an injection current control circuit to divert both positive injection and negative injection through a bypass FET that connects to GND. This implementation minimizes any shift in the supply voltage, therefore minimizing any shift in the device's ON Resistance, and thus minimizes changes in the measured analog voltage. The injection current control circuit is active on all analog pins, independent of whether the channel is selected/unselected.

1.8 V Compatible digital logic thresholds

It is common for modern systems to operate digital signals from lower voltage nodes such as 1.8 V, while operating their analog signals at higher voltage nodes such as 3.3 V or 5.0 V. To remove the requirements for a voltage translation device, the NMUX1308 digital control pins maintain 1.8 V logic compatible thresholds at higher operating voltages, up to 5.5 V.

I_{off} protection circuitry of digital inputs

The NMUX1308 implements I_{off} protection circuitry on the digital control pins, isolating those pins from the internal circuits when the supply is unpowered (i.e., V_{CC} = 0 V). The ESD protection diodes on the digital input pins do not have a connection path to V_{CC}. If the digital input pins are biased when the V_{CC} pin is unpowered:

1. The high impedance of the digital input pins minimizes input current leakage.
2. The isolation between the digital input pins and the V_{CC} pin ensures no back-powering to the supply rail.

I_{off} protection circuitry of analog inputs/outputs

The NMUX1308 implements I_{off} protection circuitry on the analog switch pins, isolating those pins from the internal circuits when the supply is unpowered (i.e., V_{CC} = 0 V). The ESD protection diodes on the analog switch pins do not have a connection path to V_{CC}. If the analog switch pins are biased when the V_{CC} pin is unpowered:

1. The high impedance of the analog pins minimizes input current leakage.
2. The isolation between the analog pins and the V_{CC} pin ensures no back-powering to the supply rail.

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3. The high impedance of the analog switch path itself minimizes signal coupling across the switch.

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care.

Input				Channel ON
$\overline{E}$	S2	S1	S0	
L	L	L	L	Y0 to Z
L	L	L	H	Y1 to Z
L	L	H	L	Y2 to Z
L	L	H	H	Y3 to Z
L	H	L	L	Y4 to Z
L	H	L	H	Y5 to Z
L	H	H	L	Y6 to Z
L	H	H	H	Y7 to Z
H	X	X	X	-

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+6.0	V
V_I	input voltage	$\overline{E}$, S0, S1, S2	[1]	-0.5	+6.0	V
V_{SW}	switch voltage	Yn, Z	[2]	-0.5	V_{CC} + 0.5	V
I_{SW}	switch current	Yn, Z; V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; T_{amb} = -40 °C to +85 °C		-50	+50	mA
		Yn, Z; V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; T_{amb} = -40 °C to +125 °C		-25	+25	mA
I_I	input current	$\overline{E}$, S0, S1, S2		-30	30	mA
I_{GND}	ground current			-100	100	mA
T_{stg}	storage temperature			-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[3]	-	500	mW
T_j	junction temperature			-	+150	°C

[1] The minimum and maximum input voltage rating may be exceeded if the input clamping current rating is observed.
[2] The minimum and maximum switch voltage rating may be exceeded if the switch clamping current rating is observed.
[3] For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.
For SOT763-1 (DHVQFN16) package: P_{tot} derates linearly with 11.2 mW/K above 106 °C.

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10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		1.5	-	5.5	V
V_I	input voltage	$\overline{E}$, S0, S1, S2	0	-	5.5	V
V_{SW}	switch voltage	Yn, Z; enable and disable mode	0	-	V_{CC}	V
		Yn, Z; V_{CC} = 0 V	0	-	5.5	V
I_{SW}	switch current	Yn, Z; V_{SW} > GND or V_{SW} < V_{CC}; T_{amb} = -40 °C to +85 °C	-50	-	50	mA
		Yn, Z; V_{SW} > GND or V_{SW} < V_{CC}; T_{amb} = -40 °C to +125 °C	-25	-	25	mA
I_{SK}	switch clamping current	Yn, Z; V_{SW} < GND or V_{SW} > V_{CC} [1]	-50	-	50	mA
I_{GND}	ground current		-100	-	100	mA
I_{INJ}	injected current	single off switch	-25	-	50	mA
		all off switches combined	-100	-	100	mA
T_{amb}	ambient temperature		-40	-	+125	°C

[1] If the V_{SW} > V_{CC} or if V_{SW} < GND, the pin will be shunted to GND through an internal FET. The current must be limited within the specified value.

11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V); for test circuit see Fig. 5.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
Analog switch										
R_{ON}	ON resistance	V_I = V_{CC} to GND; I_{SW} = 0.5 mA; $\overline{E}$ = V_{IL}; see Fig. 5								
		V_{CC} = 1.8 V ± 10%	-	450	1151	-	1245	-	1245	Ω
		V_{CC} = 2.5 V ± 10%	-	160	388	-	419	-	436	Ω
		V_{CC} = 3.3 V ± 10%	-	95	231	-	262	-	278	Ω
		V_{CC} = 5 V ± 10%	-	60	146	-	167	-	178	Ω
ΔR_{ON}	ON resistance mismatch between channels	V_I = 0.5V_{CC}; I_{SW} = 0.5 mA; $\overline{E}$ = V_{IL}								
		V_{CC} = 1.8 V ± 10%	-	5	91	-	91	-	91	Ω
		V_{CC} = 2.5 V ± 10%	-	4	35	-	39	-	41	Ω
		V_{CC} = 3.3 V ± 10%	-	2	17	-	19	-	19	Ω
		V_{CC} = 5 V ± 10%	-	1	11	-	11	-	12	Ω

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Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
$I_{S(OFF)}$	OFF-state leakage current	Yn pins; switch off; $\overline{E} = V_{IH}$; $V_I = 0.8V_{CC}$ or $0.2V_{CC}$; $V_O = 0.2V_{CC}$ or $0.8V_{CC}$; see Fig. 3								
		V_{CC} = 1.8 V ± 10%	-	±1	-	-25	25	-800	800	nA
		V_{CC} = 2.5 V ± 10%	-	±1	-	-25	25	-800	800	nA
		V_{CC} = 3.3 V ± 10%	-	±1	-	-25	25	-800	800	nA
		V_{CC} = 5 V ± 10%	-	±1	-	-25	25	-800	800	nA
		Z pins; switch off; $\overline{E} = V_{IH}$; $V_I = 0.8V_{CC}$ or $0.2V_{CC}$; $V_O = 0.2V_{CC}$ or $0.8V_{CC}$; see Fig. 3								
		V_{CC} = 1.8 V ± 10%	-	±1	-	-45	45	-800	800	nA
		V_{CC} = 2.5 V ± 10%	-	±1	-	-45	45	-800	800	nA
		V_{CC} = 3.3 V ± 10%	-	±1	-	-45	45	-800	800	nA
		V_{CC} = 5 V ± 10%	-	±1	-	-45	45	-800	800	nA
$I_{S(ON)}$	ON-state leakage current	Z, Yn pins; switch on; $\overline{E} = V_{IL}$; $V_I = V_O = 0.8V_{CC}$ or $V_I = V_O = 0.2V_{CC}$; see Fig. 4								
		V_{CC} = 1.8 V ± 10%	-	±1	-	-45	45	-800	800	nA
		V_{CC} = 2.5 V ± 10%	-	±1	-	-45	45	-800	800	nA
		V_{CC} = 3.3 V ± 10%	-	±1	-	-45	45	-800	800	nA
		V_{CC} = 5 V ± 10%	-	±1	-	-45	45	-800	800	nA
C_{SW}	switch capacitance	Yn pins, OFF-state; $V_I = 0.5V_{CC}$; f = 1 MHz								
		V_{CC} = 1.8 V ± 10%	-	3	10	-	10	-	10	pF
		V_{CC} = 2.5 V ± 10%	-	3	9	-	9	-	9	pF
		V_{CC} = 3.3 V ± 10%	-	3	9	-	9	-	9	pF
		V_{CC} = 5 V ± 10%	-	3	9	-	9	-	9	pF
		Z pin, OFF-state; $V_I = 0.5V_{CC}$; f = 1 MHz								
		V_{CC} = 1.8 V ± 10%	-	14	23	-	23	-	23	pF
		V_{CC} = 2.5 V ± 10%	-	14	22	-	22	-	22	pF
		V_{CC} = 3.3 V ± 10%	-	14	21	-	22	-	22	pF
		V_{CC} = 5 V ± 10%	-	13	20	-	20	-	20	pF
		Z, Yn pins, ON-state; $V_I = 0.5V_{CC}$; f = 1 MHz								
		V_{CC} = 1.8 V ± 10%	-	27	31	-	32	-	32	pF
		V_{CC} = 2.5 V ± 10%	-	27	31	-	31	-	31	pF
		V_{CC} = 3.3 V ± 10%	-	27	30	-	31	-	31	pF
		V_{CC} = 5 V ± 10%	-	26	29	-	30	-	30	pF

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Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
Power supply										
I_{CC}	supply current	$\overline{E}$, Sn inputs; V_I = GND or V_{CC}								
		V_{CC} = 1.8 V ± 10%	-	-	1	-	1	-	1	µA
		V_{CC} = 2.5 V ± 10%	-	-	1	-	1	-	1	µA
		V_{CC} = 3.3 V ± 10%	-	-	1	-	1	-	1	µA
		V_{CC} = 5 V ± 10%	-	-	1	-	1	-	1	µA

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V); for test circuit see Fig. 6.

Symbol	Parameter	Conditions	-40 to +125 °C			Unit
			Min	Typ [1]	Max	
Injection current coupling						
ΔV_O	output voltage variation	I_{SW} ≤ 1 mA; R_S ≤ 3.9 kΩ [2] [3]				
		V_{CC} = 1.8 V ± 10%	-	0.1	1	mV
		V_{CC} = 3.3 V ± 10%	-	0.2	1	mV
		V_{CC} = 5 V ± 10%	-	0.4	2	mV
		I_{SW} ≤ 10 mA; R_S ≤ 3.9 kΩ [2] [3]				
		V_{CC} = 1.8 V ± 10%	-	0.1	2	mV
		V_{CC} = 3.3 V ± 10%	-	0.2	2	mV
		V_{CC} = 5 V ± 10%	-	0.4	2	mV
		I_{SW} ≤ 1 mA; R_S ≤ 20 kΩ [2][3]				
		V_{CC} = 1.8 V ± 10%	-	0.1	2	mV
		V_{CC} = 3.3 V ± 10%	-	0.2	2	mV
		V_{CC} = 5 V ± 10%	-	0.4	2	mV
		I_{SW} ≤ 10 mA; R_S ≤ 20 kΩ [2][3]				
		V_{CC} = 1.8 V ± 10%	-	0.1	5	mV
		V_{CC} = 3.3 V ± 10%	-	0.2	5	mV
		V_{CC} = 5 V ± 10%	-	0.4	5	mV
Logic inputs						
V_{IH}	HIGH-level input voltage	V_{CC} = 1.8 V ± 10%	0.99	-	5.5	V
		V_{CC} = 2.5 V ± 10%	1.08	-	5.5	V
		V_{CC} = 3.3 V ± 10%	1.15	-	5.5	V
		V_{CC} = 5 V ± 10%	1.32	-	5.5	V
V_{IL}	LOW-level input voltage	V_{CC} = 1.8 V ± 10%	0	-	0.53	V
		V_{CC} = 2.5 V ± 10%	0	-	0.61	V
		V_{CC} = 3.3 V ± 10%	0	-	0.68	V
		V_{CC} = 5 V ± 10%	0	-	0.79	V
I_{IH}	HIGH-level input current	V_I = 1.8 V or V_{CC}	-	-	1	µA
I_{IL}	LOW-level input current	V_I = 0 V	-1	-	-	µA

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Symbol	Parameter	Conditions	-40 to +125 °C			Unit
			Min	Typ [1]	Max	
C_I	input capacitance	S0, S1, S2, and $\overline{E}$ pins; V_I = 0 V, 1.8 V, or V_{CC}; f = 1 MHz	-	1.5	3	pF

[1] Typical values are measured at T_{amb} = 25 °C.
[2] ΔV_O here is the maximum variation of output voltage of an enabled analog channel when current is injected into any disabled channel.
[3] I_{SW} = total current injected into all disabled channels.

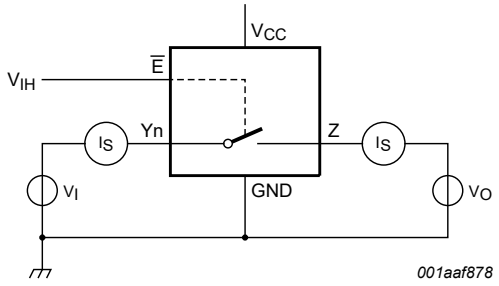
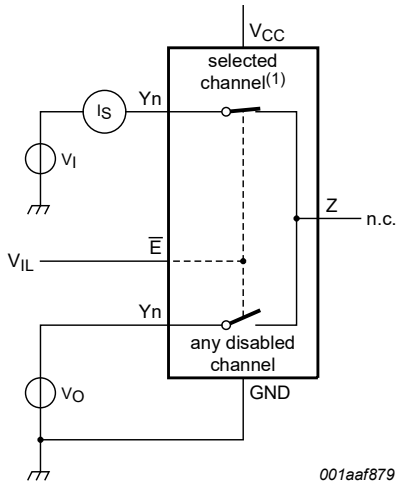
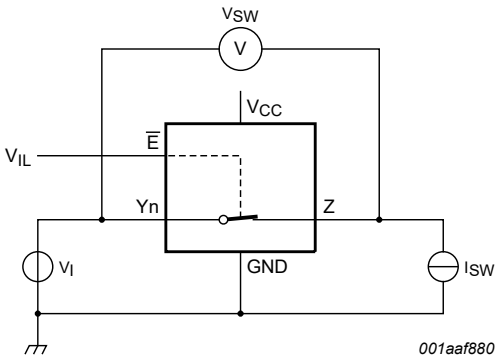


Fig. 3. Test circuit for measuring OFF-state leakage current



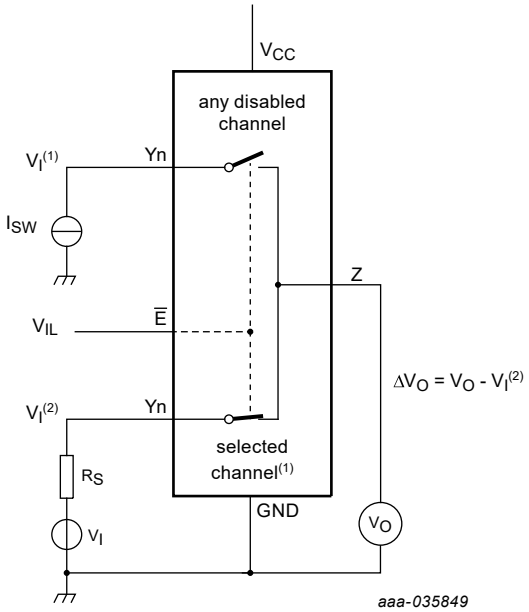
(1) Channel is selected by S0, S1 and S2.

Fig. 4. Test circuit for measuring ON-state leakage current



$R_{ON} = V_{SW} / I_{SW}$.

Fig. 5. Test circuit for measuring ON resistance



(1) Channel is selected by S0, S1 and S2.
$V_I(1) < GND$ or $V_I(1) > V_{CC}$.
$GND < V_I(2) < V_{CC}$.

Fig. 6. Test circuit for injection current coupling

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12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V); for test circuit see Fig. 10.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t_{pd}	propagation delay	Z to Yn, Yn to Z; C_L = 50 pF; see Fig. 7 [1]								
		V_{CC} = 1.8 V ± 10%	-	10	22	-	25	-	26	ns
		V_{CC} = 2.5 V ± 10%	-	6	10	-	11	-	12	ns
		V_{CC} = 3.3 V ± 10%	-	3	6	-	7	-	8	ns
		V_{CC} = 5 V ± 10%	-	2	4	-	5	-	5	ns
		V_{CC} = 5 V ± 10%; C_L = 15 pF	-	1	3	-	3	-	3	ns
t_{pd}	transition time between inputs	Sn to Z; R_L = 10 kΩ; C_L = 50 pF; see Fig. 8 [1]								
		V_{CC} = 1.8 V ± 10%	-	54	93	-	93	-	93	ns
		V_{CC} = 2.5 V ± 10%	-	41	67	-	74	-	74	ns
		V_{CC} = 3.3 V ± 10%	-	36	61	-	71	-	71	ns
		V_{CC} = 5.0 V ± 10%	-	33	60	-	70	-	70	ns
		V_{CC} = 5.0 V ± 10%; C_L = 15 pF	-	31	58	-	70	-	70	ns
		Sn to Yn; R_L = 10 kΩ; C_L = 50 pF; see Fig. 8 [1]								
		V_{CC} = 1.8 V ± 10%	-	111	359	-	363	-	364	ns
		V_{CC} = 2.5 V ± 10%	-	99	349	-	351	-	351	ns
		V_{CC} = 3.3 V ± 10%	-	96	344	-	344	-	344	ns
		V_{CC} = 5.0 V ± 10%	-	96	335	-	335	-	336	ns
		V_{CC} = 5.0 V ± 10%; C_L = 15 pF	-	39	93	-	94	-	94	ns
t_{en}	enable time	$\overline{E}$ to Z, $\overline{E}$ to Yn; R_L = 10 kΩ; C_L = 50 pF; see Fig. 9 [2]								
		V_{CC} = 1.8V ± 10%	-	15	25	-	27	-	29	ns
		V_{CC} = 2.5 V ± 10%	-	12	17	-	18	-	18	ns
		V_{CC} = 3.3 V ± 10%	-	12	17	-	18	-	18	ns
		V_{CC} = 5 V ± 10%	-	12	17	-	18	-	18	ns
		V_{CC} = 5 V ± 10%; C_L = 15 pF	-	11	16	-	17	-	17	ns

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Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t_{dis}	disable time	$\overline{E}$ to Z, $\overline{E}$ to Yn; R_L = 10 kΩ; C_L = 50 pF; S1 = GND; see Fig. 9 [3]								
		V_{CC} = 1.8 V ± 10%	-	22	47	-	48	-	49	ns
		V_{CC} = 2.5 V ± 10%	-	20	37	-	37	-	37	ns
		V_{CC} = 3.3 V ± 10%	-	18	37	-	37	-	37	ns
		V_{CC} = 5 V ± 10%	-	18	31	-	32	-	33	ns
		V_{CC} = 5 V ± 10%; C_L = 15 pF	-	3	5	-	5	-	6	ns
		$\overline{E}$ to Z, $\overline{E}$ to Yn; R_L = 10 kΩ; C_L = 50 pF; S1 = V_{CC}; see Fig. 9 [3]								
		V_{CC} = 1.8 V ± 10%	-	14	72	-	72	-	72	ns
		V_{CC} = 2.5 V ± 10%	-	11	70	-	70	-	71	ns
		V_{CC} = 3.3 V ± 10%	-	10	70	-	70	-	70	ns
		V_{CC} = 5 V ± 10%	-	9	69	-	69	-	70	ns
		V_{CC} = 5 V ± 10%; C_L = 15 pF	-	6	34	-	34	-	35	ns
t_{b-m}	break-before-make time	R_L = 10 kΩ; C_L = 15 pF; Yn to Z								
		V_{CC} = 1.8 V ± 10%	1	35	-	1	-	1	-	ns
		V_{CC} = 2.5 V ± 10%	1	30	-	1	-	1	-	ns
		V_{CC} = 3.3 V ± 10%	1	30	-	1	-	1	-	ns
		V_{CC} = 5 V ± 10%	1	30	-	1	-	1	-	ns

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.
[2] t_{en} is the same as t_{PZH} and t_{PZL}.
[3] t_{dis} is the same as t_{PLZ} and t_{PHZ}.

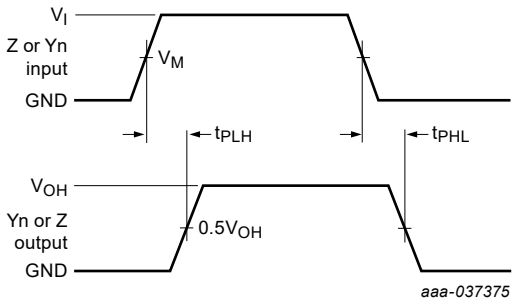
Table 10. Dynamic characteristics

Symbol	Parameter	Conditions	T_{amb} = -40 °C to +125 °C			Unit
			Min	Typ	Max	
Q_{inj}	charge injection	V_I = 0.5V_{CC}; R_S= 0 Ω; C_L = 100 pF				
		V_{CC} = 1.8 V ± 10%	-	1	-	pC
		V_{CC} = 2.5 V ± 10%	-	2	-	pC
		V_{CC} = 3.3 V ± 10%	-	3	-	pC
		V_{CC} = 5 V ± 10%	-	8	-	pC
α_{iso}	isolation (OFF-state)	V_{bias} = 0.5V_{CC}; V_I = 200 mVpp; R_L = 50 Ω; C_L = 5 pF; f = 100 kHz				
		V_{CC} = 1.8 V ± 10%	-	-125	-	dB
		V_{CC} = 2.5 V ± 10%	-	-125	-	dB
		V_{CC} = 3.3 V ± 10%	-	-125	-	dB
		V_{CC} = 5 V ± 10%	-	-125	-	dB
		V_{bias} = 0.5V_{CC}; V_I = 200 mVpp; R_L = 50 Ω; C_L = 5 pF; f = 1 MHz				
		V_{CC} = 1.8 V ± 10%	-	-100	-	dB
		V_{CC} = 2.5 V ± 10%	-	-100	-	dB
		V_{CC} = 3.3 V ± 10%	-	-100	-	dB
		V_{CC} = 5 V ± 10%	-	-100	-	dB

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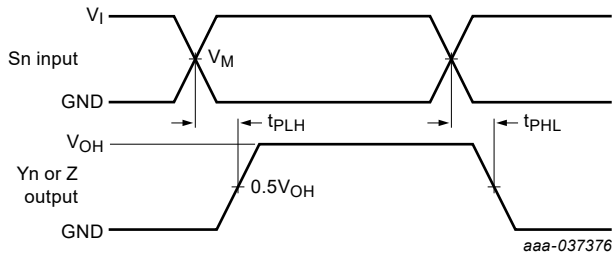
Symbol	Parameter	Conditions	T_{amb} = -40 °C to +125 °C			Unit
			Min	Typ	Max	
X_{talk}	crosstalk	V_{bias} = 0.5V_{CC}; V_I = 200 mVpp; R_L = 50 Ω; C_L = 5 pF; f = 100 kHz				
		V_{CC} = 1.8 V ± 10%	-	-105	-	dB
		V_{CC} = 2.5 V ± 10%	-	-105	-	dB
		V_{CC} = 3.3 V ± 10%	-	-105	-	dB
		V_{CC} = 5 V ± 10%	-	-105	-	dB
		V_{bias} = 0.5V_{CC}; V_I = 200 mVpp; R_L = 50 Ω; C_L = 5 pF; f = 1 MHz				
		V_{CC} = 1.8 V ± 10%	-	-80	-	dB
		V_{CC} = 2.5 V ± 10%	-	-80	-	dB
		V_{CC} = 3.3 V ± 10%	-	-80	-	dB
		V_{CC} = 5 V ± 10%	-	-80	-	dB
BW	Bandwidth	V_{bias} = 0.5V_{CC}; V_I = 200 mVpp; R_L = 50 Ω; C_L = 5 pF				
		V_{CC} = 1.8 V ± 10%	-	270	-	MHz
		V_{CC} = 2.5 V ± 10%	-	300	-	MHz
		V_{CC} = 3.3 V ± 10%	-	315	-	MHz
		V_{CC} = 5 V ± 10%	-	325	-	MHz

12.1. Waveforms and test circuit



Measurement points are given in Table 11.
Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

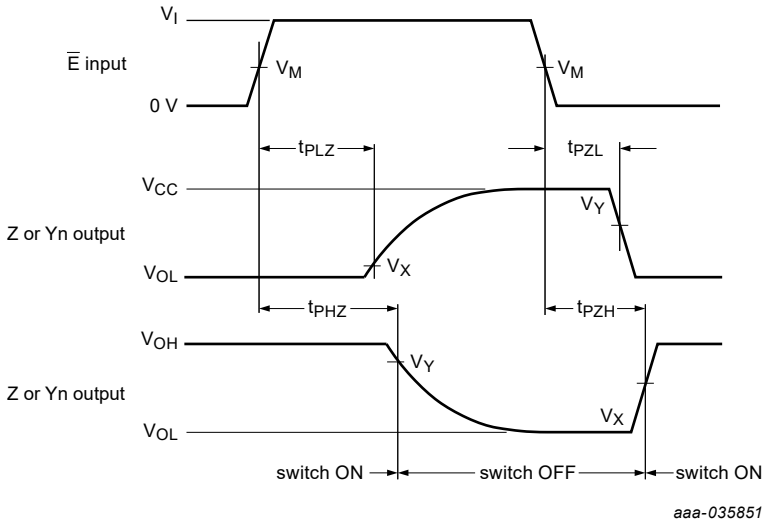
Fig. 7. Input (Z, Yn) to output (Yn, Z) propagation delays



Measurement points are given in Table 11.
Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 8. Input (Sn) to output (Yn, Z) propagation delays

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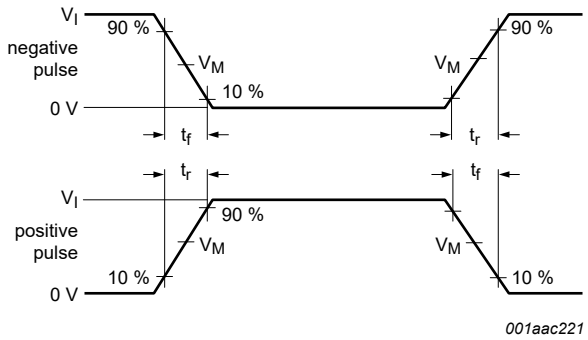
Measurement points are given in Table 11.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

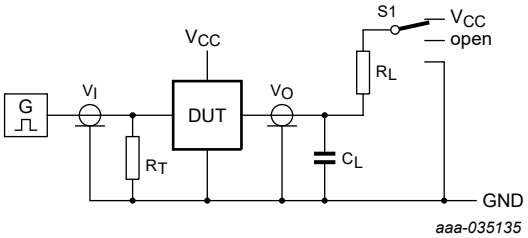
Fig. 9. Enable and disable times

Table 11. Measurement points

Input		Output	
V_M	**V_I**	**V_X**	**V_Y**
0.5 × V_{CC}	V_{CC}	V_{OL} + 0.1(V_{CC} - V_{OL})	0.9 × V_{OH}



a. Input pulse definition



b. Test circuit

Test data is given in Table 12.

Definitions for test circuit:

R_L = load resistance;

C_L = load capacitance including jig and probe capacitance;

R_T = termination resistance should be equal to the output impedance Z_O of the pulse generator.

Fig. 10. Test circuit for measuring switching times

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Table 12. Test data

Test	Input			Output		S1 position
	Control $\overline{E}$, Sn	Switch Yn (Z)	t_r, t_f	Switch Z (Yn)		
	V_I	V_I		C_L	R_L	
t_{PHL}, t_{PLH}	V_{CC}	V_{CC}	< 5 ns	50 pF	-	open
t_{PHZ}, t_{PZH}	V_{CC}	V_{CC}	< 5 ns	50 pF	10 kΩ	GND
t_{PLZ}, t_{PZL}	V_{CC}	V_{CC}	< 5 ns	50 pF	10 kΩ	V_{CC}

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13. Application information

NMUX1308

The NMUX1308 is a versatile CMOS bi-directional 8-channel (8:1) analog switch designed for general-purpose use, operating within a voltage range of 1.5 V to 5.5 V. It features 5.5V overvoltage tolerant digital inputs and is compatible with 1.8 V CMOS levels, eliminating the need for voltage translation.

Each analog signal pin on the NMUX1308 incorporates injection current control circuitry. This innovative feature serves to isolate overvoltage spikes on disconnected analog signal pins, preventing them from affecting the connected analog signal path. Two other protective features include Fail-Safe-Logic and Power-off-Protection. These attributes make the NMUX130X family of devices the ideal choice for applications aiming to simplify signal management and reduce system complexity, resulting in a lower component count and a smaller PCB area. This utilization allows users to adopt a design approach centered around modularity, reuse, and scalability.

Typical application schematic

A typical example is provided in Fig. 11. In this instance, various sensor and voltage inputs are sequentially accessed by the input of the SAR ('Successive Approximation Register') ADC. In the example below, the SAR ADC is integrated in the Microcontroller. The operational amplifier serves the purpose of satisfying the SAR ADC recommendation of being driven with a low-impedance source, especially when input sensors or signals have large output impedance. This enhancement improves the performance of the SAR ADC, ensuring fast and accurate conversions while minimizing errors during the sampling process. Additionally, the op-amp eliminates potential error sources, such as ADC input leakage current, that can cause a small drop, resulting in a minor voltage error across the analog multiplexer.

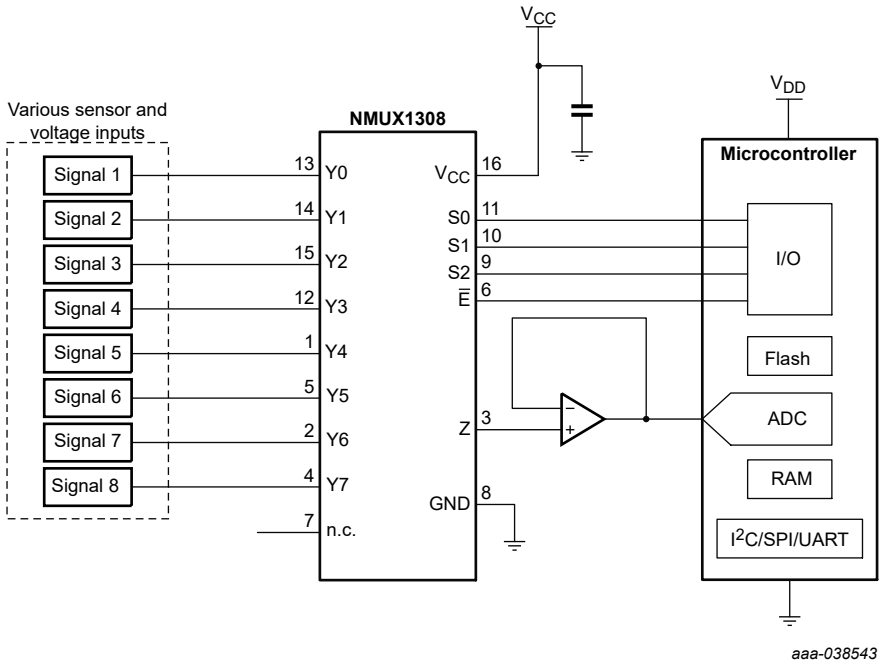


Fig. 11. 8-channel multiplexing with NMUX1308 to Microcontroller with integrated ADC

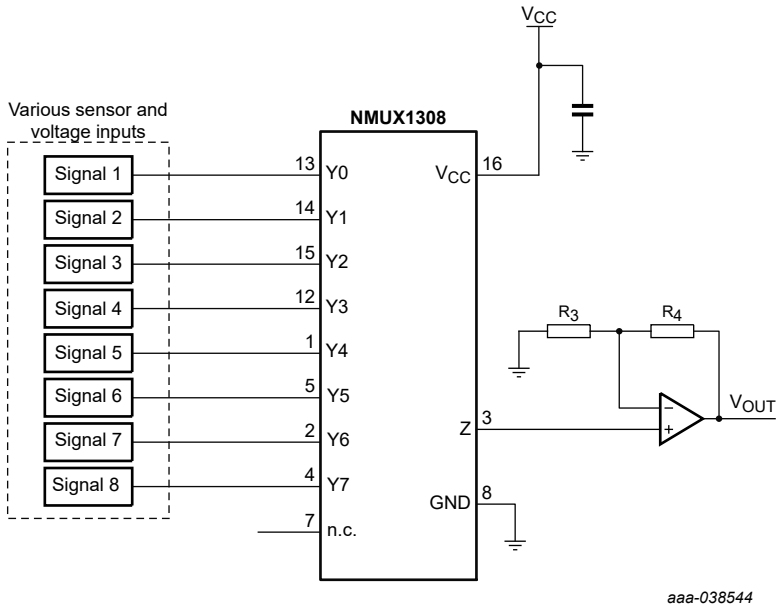
The benefits of this design type include the capability to route and switch multiple analog signals through a single channel. This is particularly crucial when the number of ADC input channels is limited.

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Table 13. Example design parameters with NMUX1308

Important Design Parameters	Example Value
Supply range (V_{CC})	1.5 V to 5.5 V
Analog input voltage range	0 V to V_{CC} (rail-to-rail)
Control input logic	1.8 V compatible (5.5 V overvoltage tolerant)
I_{SW} independent switch current (maximum)	50 mA
Total analog input continuous current to GND (maximum)	100 mA

Additional example application



$$V_{OUT} = V_{IN} \times \left(1 + \frac{R_4}{R_3}\right)$$

Fig. 12. NMUX1308 with non-inverting GAIN stage. V_{IN} = multiplexed signal voltages

NMUX1308 layout example

The image provided below (Fig. 13) offers a glimpse into an example PCB layout with the (PW) package. Bypass capacitors should be positioned near the V_{CC} pin, and the GND pin should be connected to external/internal GND planes. A uniform GND plane helps in reducing noise and minimizing loop inductance, thereby ensuring optimal performance.

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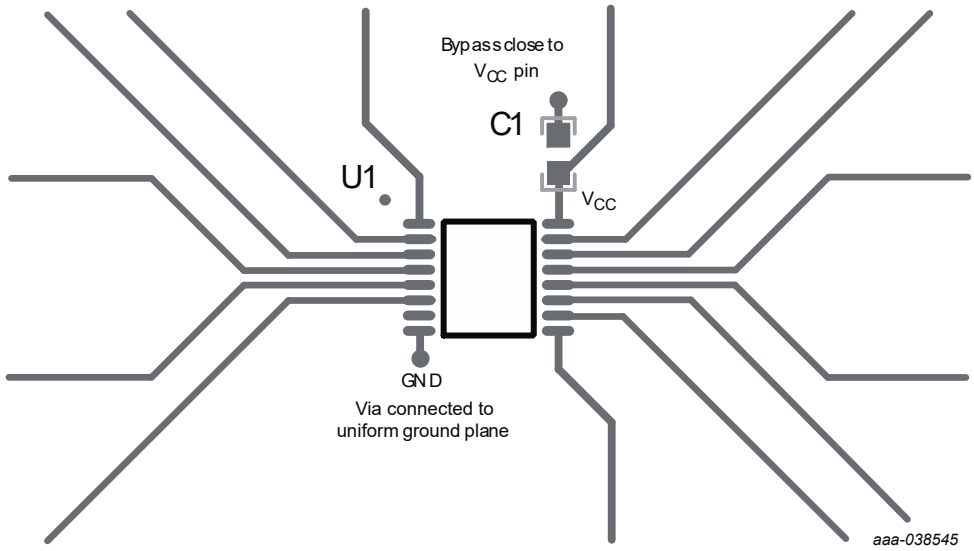


Fig. 13. NMUX1308 layout example with NMUX1308PW (TSSOP16/SOT403-1) package

Layout recommendations

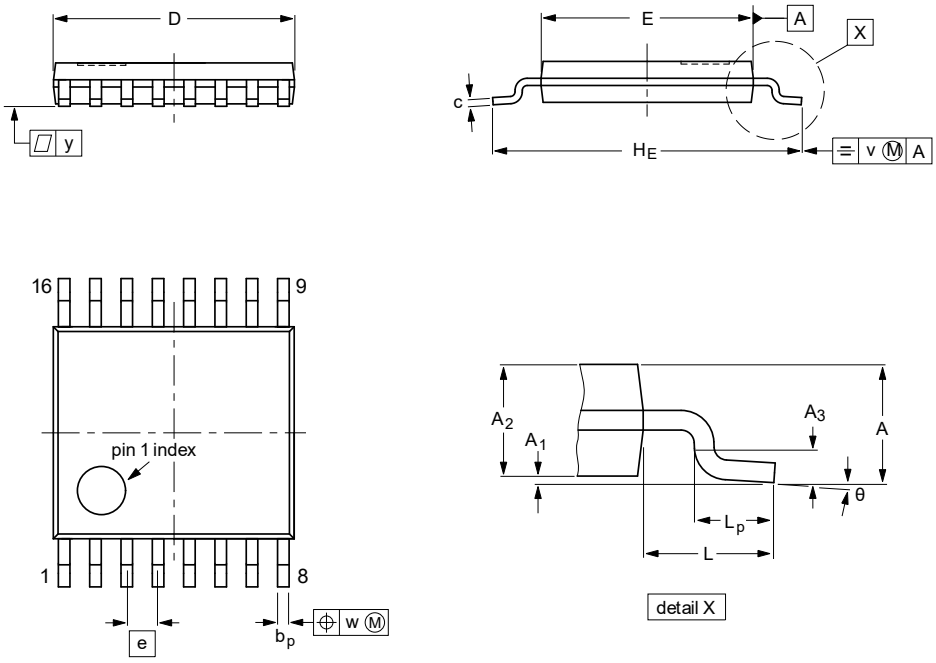
As with all board designs, proper layout techniques should be employed. Some quick good layout practices and considerations are listed below for quick reference.

- Ceramic capacitors with low ESR should be used to properly decouple or bypass power-supply pins. Ceramic capacitors with high temperature coefficients and low dissipation factors include X5R, X7R and NP0. The recommended minimum value is 0.1 µF.
- For improved noise suppression, additional bypass capacitors can be implemented. It is a common practice to use two different capacitor values to ensure proper filtering of both low-frequency and high-frequency transients. The smaller capacitor, typically in a 0402 package, is placed very near the device pin, while the larger capacitor is positioned farther away.
- To minimize coupling and improve performance all switching nets should travel across a uniform ground plane. Reducing crosstalk can also be achieved by separating traces with a small polygon ground plane.
- Net traces should only have serpentine or 45° bend. Sharper bends, such as 90° should be avoided.

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14. Package outline

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm **SOT403-1**



Dimensions (mm are the original dimensions)

Unit		A	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(2)}$	e	H_E	L	L_p	v	w	y	θ
mm	max	1.20	0.15	1.05		0.30	0.2	5.1	4.5		6.6		0.75				8°
	nom				0.25					0.65		1		0.2	0.1	0.1	
	min		0.05	0.80		0.19	0.09	4.9	4.3		6.2		0.45				0°

Note
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

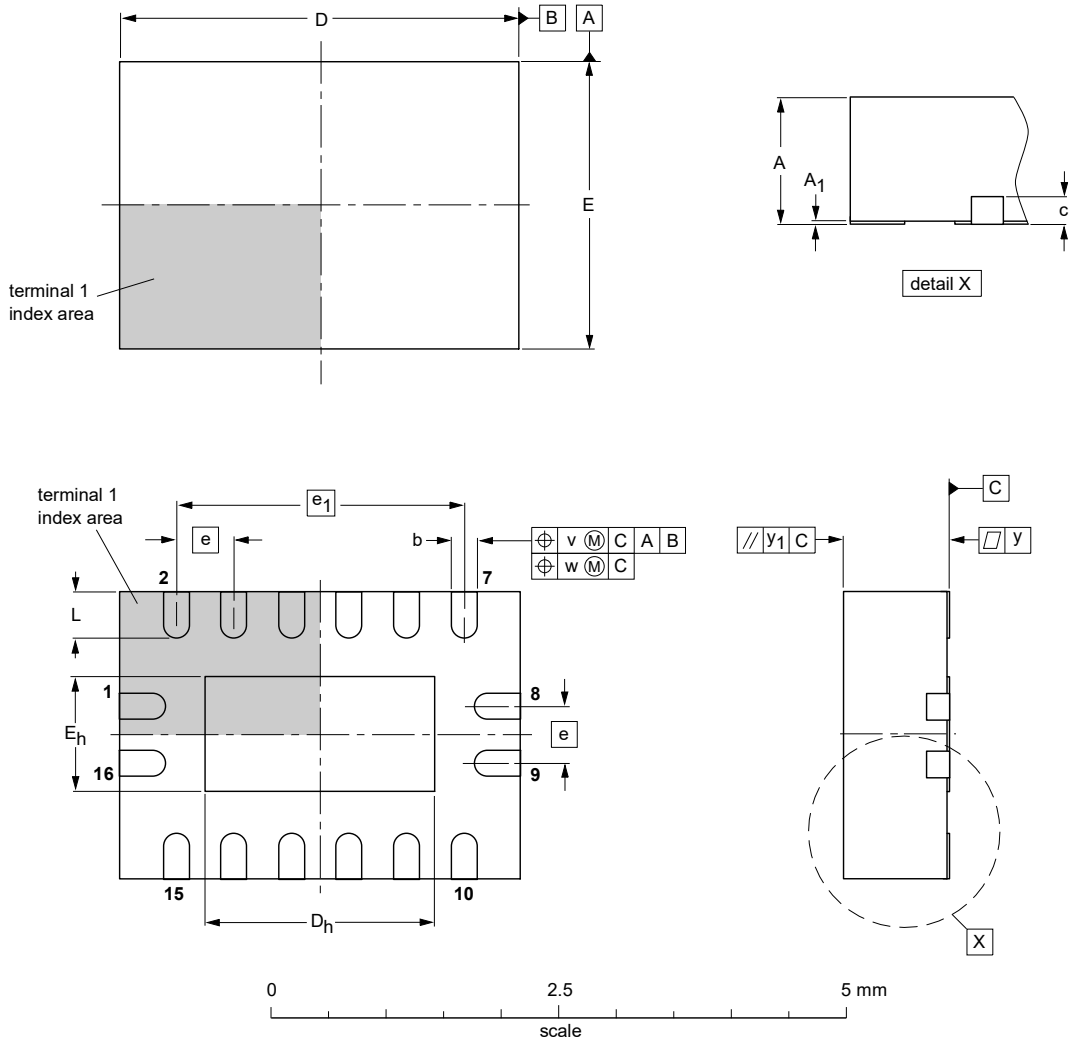
sot403-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT403-1		MO-153				~~03-02-18~~ 23-10-27

Fig. 14. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm **SOT763-1**



DIMENSIONS (mm are the original dimensions)

UNIT	$A^{(1)}$ max.	A_1	b	c	$D^{(1)}$	D_h	$E^{(1)}$	E_h	e	e_1	L	v	w	y	y_1
mm	1	0.05 0.00	0.30 0.18	0.2	3.6 3.4	2.15 1.85	2.6 2.4	1.15 0.85	0.5	2.5	0.5 0.3	0.1	0.05	0.05	0.1

Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT763-1	- - -	MO-241	- - -			~~02-10-17~~ 03-01-27

Fig. 15. Package outline SOT763-1 (DHVQFN16)

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15. Abbreviations

Table 14. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model

16. Revision history

Table 15. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NMUX1308 v. 1.2	20240416	Product data sheet	-	NMUX1308 v. 1.1
Modification	• Section 7.1: Pin configuration drawing of the SOT403-1/TSSOP16 package corrected. (Errata)			
NMUX1308 v. 1.1	20240221	Product data sheet	-	NMUX1308 v. 1
Modification	• Section 5: added. • Fig. 10: Errata.			
NMUX1308 v. 1	20240118	Product data sheet	-	-

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Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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